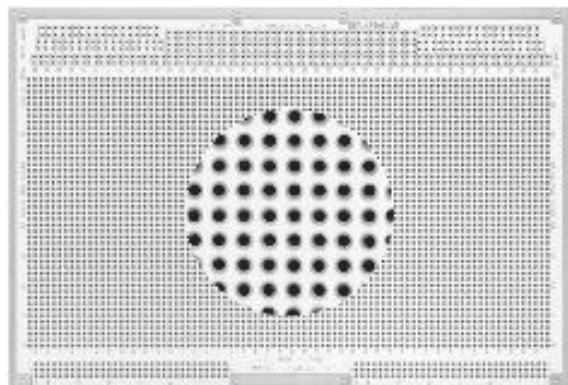




## E160-6U-3

## 6U X 160MM

**Circuit Pattern:**

**Width/Thick:**

**Height:**

**16-Pin DIP Capacity:**

**Material:**

**Wire-Wrap Terminals:**

**Wire-Wrap Socket Pins:**

**Rec. Card Cage:**

**96-Pin Din Connector:**

**Hole Diameter:**

Voltage/Ground Plane

6.30"/.062"

9.19"

105

FR4 Epoxy Glass

T44, T46, T49, T68

R50, R51, R52, R53

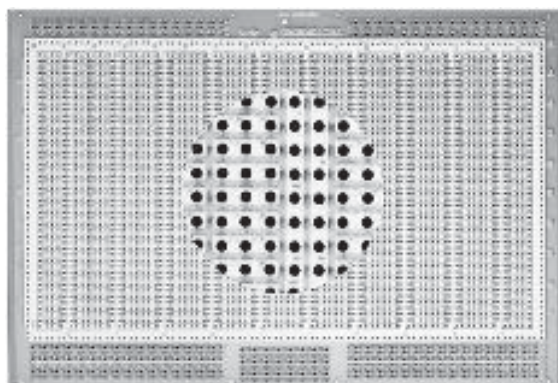
CCK160-6U

RE96MWR

(Available Separately)

.055"

- Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eye lets, available separately ) for use without pins)
- Layout paper and instructions included
- Row and column legends provided



## 4615

## 6U X 160MM

**Circuit Pattern:**

**Width/Thick:**

**Height:**

**16-Pin DIP Capacity:**

**Material:**

**Wire-Wrap Terminals:**

**Wire-Wrap Socket Pins:**

**Rec. Card Cage:**

**96-Pin Din Connector:**

**Hole Diameter:**

3-Hole Solder Pad

6.30"/.062"

9.19"

50

FR4 Epoxy Glass

T44, T46, T49, T68

R32

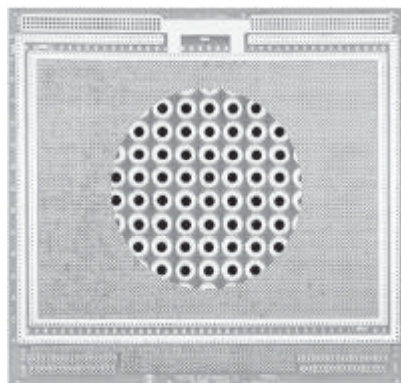
CCK160-6U

RE96MWR

(Available Separately)

.042"

- 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads
- Bus and pad surfaces solder-coated for user convenience
- Interleaved buses on both sides, back-to-back
- Layout paper and instructions included
- Row and column legends provided



## E220-6U-1

## 6U X 220MM

**Circuit Pattern:**

**Width/Thick:**

**Height:**

**16-Pin DIP Capacity:**

**Material:**

**Wire-Wrap Terminals:**

**Wire-Wrap Socket Pins:**

**Rec. Card Cage:**

**96-Pin Din Connector:**

**Hole Diameter:**

Pad-per-hole

8.66"/0.62"

9.19"

140

FR4 Epoxy Glass

T44, T46, T49, T68

R32

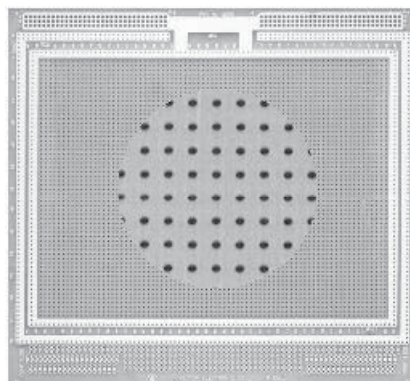
CCK220-6U

RE96MWR

(Available Separately)

.042"

- Plated-thru holes
- Voltage and ground buses around board perimeter both sides
- Pad and Bus surfaces solder-coated for user convenience
- Also accepts PGA's and PLCC's
- Layout paper and instructions included
- Row and column legends provided



## E220-6U-2

## 6U X 220MM

**Circuit Pattern:**

**Width/Thick:**

**Height:**

**16-Pin DIP Capacity:**

**Material:**

**Wire-Wrap Terminals:**

**Wire-Wrap Socket Pins:**

**Rec. Card Cage:**

**96-Pin Din Connector:**

**Hole Diameter:**

Peripheral Buses

8.66"/.062"

9.19"

140

FR4 Epoxy Glass

T44, T46, T49, T68

R32

CCK220-6U

RE96MWR

(Available Separately)

.042"

- Voltage and ground buses around board perimeter both sides
- Bus surfaces solder-coated for user convenience
- Also accepts PGA's and PLCC's
- 58 x 78 grid unrestricted component placement area
- Layout paper and instructions included
- Row and column legends provided

**E220-6U-3****6U X 220MM****Circuit Pattern:****Width/Thick:****Height:****16-Pin DIP Capacity:****Material:****Wire-Wrap Terminals:****Wire-Wrap Socket Pins:****Rec. Card Cage:****96-Pin Din Connector:****Hole Diameter:**

Voltage/Ground plane

8.66"/.062"

9.19"

168

FR4 Epoxy Glass

T44, T46, T49, T68

R50, R51, R52, R53

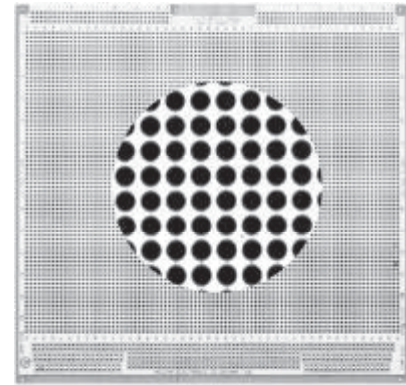
CCK220-6U

RE96MWR

(Available Separately)

.055"

- Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution
- Plane surfaces solder-coated for user convenience
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- Layout paper and instructions included

**9U****E280-9U-1****9U X 280MM****Hole Diameter:****Circuit Pattern:****Width/Thick:****Height:****16-Pin DIP Capacity:****Material:****Wire-Wrap Terminals:****Wire-Wrap Socket Pins:****Rec. Card Cage:****96-Pin Din Connector:**

.042"

Pad-Per-Hole

11.02"/.062"

14.44"

270

FR4 Epoxy Glass

T44, T46, T49, T68

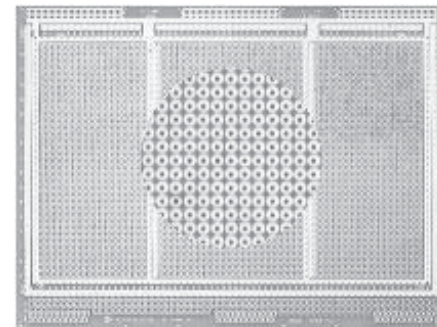
R32

CCK280-9U

RE96MWR

(Available Separately)

- Voltage and ground buses around board perimeter both sides
- Accepts PGA and PLCC devices
- Additional power and ground buses in signal area
- Layout paper and instructions included
- Row and column legends provided
- Plated-thru holes

**E280-9U-2****9U X 280MM****Circuit Pattern:****Width/Thick:****Height:****16-Pin DIP Capacity:****Material:****Wire-Wrap Terminals:****Wire-Wrap Socket Pins:****Rec. Card Cage:****96-Pin Din Connector:****Hole Diameter:**

Peripheral Buses

11.02"/.062"

14.44"

270

FR4 Epoxy Glass

T44, T46, T49, T68

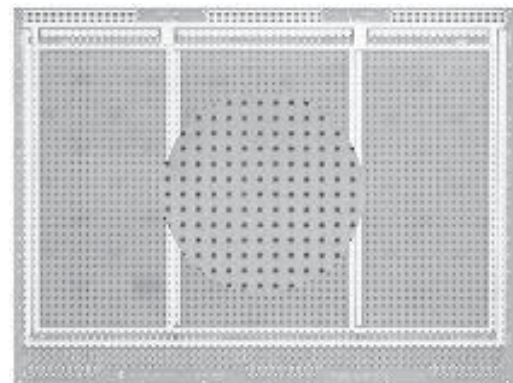
R32

CCK280-9U

RE96MWR

.042"

- Voltage and ground buses around board perimeter both sides
- Bus surfaces solder-coated for user convenience
- Capacity for mounting 270, 16-pin DIP IC devices; also accepts PGA and PLCC devices
- Additional power and ground buses in signal area
- Three 79 x 36 grid unrestricted component placement areas
- Layout paper and instructions included
- Row and column legends provided

**E280-9U-3****9U X 280MM****Circuit Pattern:****Width/Thick:****Height:****16-Pin DIP Capacity:****Material:****Wire-Wrap Terminals:****Wire-Wrap Socket Pins:****Rec. Card Cage:****96-Pin Din Connector:****Hole Diameter:**

Voltage/Ground Plane

11.02"/.062"

14.44"

348

FR4 Epoxy Glass

T44, T46, T49, T68

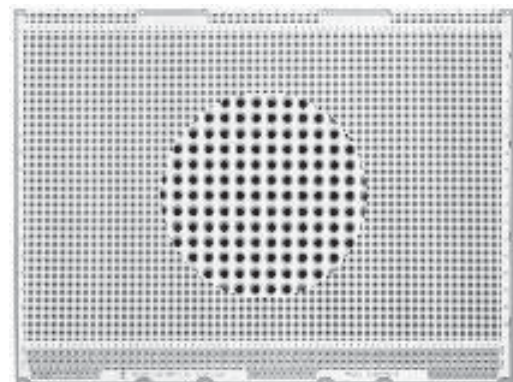
R50, R51, R52, R53

CCK280-9U

RE96MWR

.055"

- Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution
- Additional power and ground buses in signal area
- To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)
- Layout paper and instructions included
- Row and column legends provided





## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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